

**10 Gb/s, 850 nm  
Multimode, 300 m  
XENPAK Dual SC Package**

**Description**

OptixCom's XENPAK fiber optics transceiver is designed with advanced 850 nm VCSEL laser and high speed electronics to achieve the optimum performance for optical interconnect applications. It is compliant with the XENPAK Multi-Source Agreement (MSA).

XENPAK uses 70-pin hot pluggable electrical connector and supports four lane XAUI (10 Gigabit attachment unit interface) at both Ethernet (3.125 Gb/sec) and/or Fiber Channel (3.1875 Gb/sec) rates.

The transceiver uses duplex SC connector for the optical interface. The transceiver has 4-9 dB of power budget and reaches up to 300 meters of transmission distance with OM3 multimode fibers. The product is RoHS compliant. Total power consumption is < 2.4W.



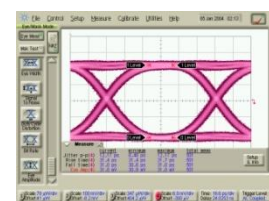
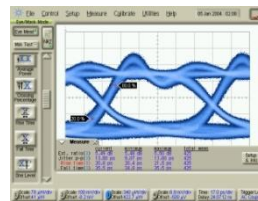
**XEN-10000SX-AT300M**



10 Gb/s, 2<sup>31</sup>-1 NRZ data eye pattern

**TX**

**RX**



**Key Features**

- Standard XAUI interface with 3Gb/s per channel
- 850 nm multimode, 300 m, 10 Gb/s data rate
- >4 dB power budget
- Duplex SC connector optical interface
- 70-pin Z-axis hot pluggable connector
- AC coupling CML differential I/O logics
- Compliant with XENPAK MSA standard
- Compliant with IEEE 802.3ae, 10GBASE-SW/SR
- Compliant with 10G FC Fiber Channel Standard
- RoHS compliant

**Applications**

- ✓ 10G Fiber Channel & Ethernet
- ✓ OC192/STM-64 for SONET/SDH
- ✓ High speed I/O for file server
- ✓ Data Communication for SAN and LAN
- ✓ Central offices routers and switches
- ✓ Mass storage systems interconnect
- ✓ Computer cluster cross-connect

**Ordering Information**

**Part Number:** XEN-10000SX-AT300M

**Description:**

850 nm 10 Gb/s, multimode, XENPAK fiber optics transceiver, 300 m reach, 0-70°C

**Operating Conditions**

Parameter	Min.	Typical	Max.	Units
Operate Temperature	0	25	70	°C
Data Rate	9.95	---	11.3	Gb/s
Adaptable Power Supply	1.15	1.2	1.25	V
Power Supply Vcc	3.1	3.3	3.5	V
Power Dissipation	---	1.7	2.4	W

**Absolute Maximum Ratings**

Parameter	Symbol	Min.	Max.	Units
Storage Temperature	$T_{st}$	-40	85	°C
Adaptable Power Supply (APS)	$V_{aps}$	0	1.5	V
Supply Voltage @ 3.3V	$V_{cc}$	-0.5	4.0	V
Humidity	$R.H.$	0	85	%

**Typical Transmission Distance for Multimode Fibers @ 850 nm**

Data Rate	Fiber Type	Distance (m)	Data Rate	Fiber Type	Distance (m)
1.25 Gb/s	50 $\mu$ m, 500 MHz*km	550	10 Gb/s	50 $\mu$ m, 2000 MHz*km	300
	50 $\mu$ m, 400 MHz*km	500		50 $\mu$ m, 500 MHz*km	82
	62.5 $\mu$ m, 200 MHz*km	275		62.5 $\mu$ m, 200 MHz*km	33
	62.5 $\mu$ m, 160 MHz*km	220		62.5 $\mu$ m, 160 MHz*km	26

**Transmitter Electro-Optical Characteristics**

Parameter	Symbol	Min.	Typical	Max.	Units
XAUI Data Rate	$X_{DR}$	---	3.125	---	Gb/s
XAUI Baud Rate Tolerance	$X_{BRT}$	-100	---	+100	ppm
Differential Input Voltage <sup>1</sup>	$\Delta V_i$	0.2	---	1.6	V
Differential Input Impedance <sup>2</sup>	$Z$	---	100	---	ohm
Optical Output Power <sup>3</sup>	$P_o$	-6.5	---	-1	dBm
Transmitter & Dispersion Penalty	$T_{DP}$	---	---	3.2	dB
Optical Wavelength	$\lambda_o$	840	850	860	nm
Optical Modulation Amplitude	$OMA$	525	---	---	$\mu$ W
Extinction Ratio	$ET$	3.5	---	---	dB
Spectral Width (rms)	$\Delta\lambda$	---	0.4	0.45	dB
Total Output Jitter	$T_{OJ}$	---	---	0.35	UI
Total Deterministic Output Jitter	$T_{DJ}$	---	---	0.17	UI

Notes:

1. Module is designed for AC coupling. DC voltage will be filtered by internal capacitors.
2. Single ended will be 50 ohm for each signal line.
3. Output of coupling optical power into 50/125  $\mu$ m MMF.
4. Refer to OptixCom "XENPAK Design Reference Guide" or IEEE 802.3ae for more design details.

**Receiver Electro-Optical Characteristics**

Parameter	Symbol	Min.	Typical	Max.	Units
Operating Wavelength	$\lambda_c$	840	---	860	nm
Receiver Sensitivity <sup>1</sup>	$P_i$	-9.9	---	-1.0	dBm
Receiver Sensitivity in OMA <sup>1</sup>	$P_{iOMA}$	---	---	-11.1	dBm
RX Stressed Sensitivity in OMA <sup>1</sup>	$P_{sOMA}$	---	---	-7.5	dBm
Differential Output Voltage	$\Delta V_o$	0.8	---	1.6	V
Differential Input Impedance <sup>2</sup>	$Z$	---	100	---	Ohm

Notes:

1. Test at 10 Gb/s, 2<sup>31</sup> – 1 PRBS data pattern, and > 1x10<sup>-12</sup> of Bit-Error-Rate (BER).
2. Single ended will be 50 ohm for each signal line.
3. Refer to OptixCom "XENPAK Design Reference Guide" or IEEE 802.3ae for more design details.

**Electrical Signal Characteristics**

Parameter	Symbol	Min.	Typical	Max.	Units
1.2 V CMOS					
Input High Voltage	$V_{IH(MAX)}$	---	---	0.36	V
Input Low Voltage	$V_{IL(MIN)}$	0.84	---	1.25	V
Capacitance		---	---	320	pF
Pull Up Resistance	$R_{pull}$	10k	---	22k	Ohm
MDIO I/O					
Output Low Voltage	$V_{OL}$	-0.3	---	0.2	V
Output Low Current	$I_{OL}$	---	---	4	mA
Input High Voltage	$V_{IH}$	0.84	---	1.5	V
Input Low Voltage	$V_{IL}$	-0.3	---	0.36	V
Pull-Up Supply Voltage	$V_{PULL}$	1.14	1.2	1.26	
Input Capacitance	$C_{IN}$	---	---	10	pF
Load Capacitance	$C_{LOD}$	---	---	470	pF
External Pull-Up Resistance	$E_{pull}$	200	---	---	Ohm

**Class 1 Laser Product  
Complies with  
21 CFR 1040.10 and 1040.11**

